

Description

CTS model 1500002 is a small size, high performance SMT OCXO for use in telecom switching, and wireless communication applications.

Electrical Specifications

| Parameter | Conditions & Remarks | Min | Typical | Max | Unit |
|--------------------------------|--|-------|---------|------------|------------|
| Operating Conditions | | | | | |
| Operating Temperature Range | T _{op} ; max. rate of change 0.5°C/minute | -40 | - | +85 | °C |
| Supply Voltage | V _{cc} ; ± 5% | 3.135 | 3.3 | 3.465 | Vdc |
| Power Consumption | P _{MAX} Steady State; T _A = 25°C; Still Air | - | - 0.6 | 2.5 1.0 | W |
| Load | | 13.5 | 15 | 16.5 | рF |
| Frequency Stability | | | | | |
| Frequency | F _{NOM} | | 12.800 | | MHz |
| Calibration | Δ F/F _{NOM} ; T _A = 25°C; V _{CC} = 3.3Vdc at time of shipment | - | - | ±0.5 | ppm |
| Temperature Stability | Δ F/F ; referenced to 25°C | - | - | ±100 | ppb |
| Frequency vs. Voltage | V _{CC} ±5% | - | - | ±50 | ppb |
| Frequency vs. Load | 15 pf ±5% | - | - | ±50 | ppb |
| Aging | Per day | - | ±2 | - | ppb |
| (After 30 days continuous | Per year | - | ±300 | - | ppb |
| operation) | 20 years | - | ±3 | - | ppm |
| Free run accuracy | All causes – 20 years | - | - | ±4.6 | ppm |
| Short Term Stability (ADEV) | 1.0 sec | - | - | 0.1 | ppb |
| Warm-up time | @ 25°C, After 5 mins referenced to the freq after 1 hour on | - | - | ±500 | ppb |
| Lleldever (still ein) | - Constant temperature (24 hrs) | - | - | ±10 | ppb |
| Holdover (still air) | - Variable temperature | - | _ | 250 | ppb, pk-pk |
| Wander Generation | Meets Stratum 3 MTIE and TDEV per Telcordia GR-1244-CORE | | | | |

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Model 1500002

12.8 MHz, 9x14mm Stratum 3 OCXO

Electrical Specifications (Continued)

| Parameter | Conditions & Remarks | | Min | Typical | Max | Unit |
|-------------------|-----------------------|--------|-----|---------|-----|--------|
| Output Parameters | | | | | | |
| Output Signal | LVCMOS Square Wave | | | | | |
| Amplitude | V _{OL} | | - | - | 0.4 | Vdc |
| | V _{OH} | | 2.4 | - | - | |
| Rise/Fall Times | 10% to 90%, 15pf load | | - | - | 5 | ns |
| Duty Cycle | @50% of output signal | | 45 | 50 | 55 | % |
| Phase Noise | | 1Hz | - | -70 | - | |
| | | 10Hz | - | -100 | - | |
| | | 100Hz | - | -125 | - | dBc/Hz |
| | | 1KHz | - | -142 | - | |
| | | 10KHz | - | -148 | - | |
| | | 100KHz | - | -151 | - | |

Typical Stratum 3 Wander Generation performance per Telcordia GR-1244-CORE (locked through a 0.1Hz loop bandwidth)





Mechanical and Environmental

| Storage Temp Range | -55 to +105°C | | |
|----------------------|--|--|--|
| Operating Temp Range | -40 to +85°C | | |
| Poflow Profile | IPC/JEDEC J-STD-20; >217°C, 1.5 min and 245°C (Absolute max temperature),10 secs. | | |
| Renow Profile | Note: Part is not designed to be reflowed in an inverted position | | |
| Machanical Shack | 100g, 6mS duration, 1/2 sine wave, 3 shocks each direction along 3 mutually perpendicular | | |
| | planes. | | |
| Drop | 10 cm height, 3 times onto hard board with thickness 3cm IEC60028-2-32 test Ed | | |
| | Random: Frequency range: 1Hz-4Hz-100Hz-200 | | |
| Vibration | Acceleration: 0.0001g ² /Hz-0.01g ² /Hz-0.01g ² /Hz-0.001g ² /Hz | | |
| VIDIATION | Grms=1.15g – 30 minutes per axis | | |
| | Sine: 10 – 55 Hz, 0.75mm DA, Sweep time 30 minutes per axis | | |
| Thermal Shock | -40°C \sim +85°C; 0.5 hour dwells with <30 second transitions. 100 cycles | | |
| RoHS | Lead-Free. Fully compliant to RoHS Directive 2011/65/EU | | |
| MSL | Level 2 | | |

Mechanical Specifications

Package Drawing



| PAD | Connection | |
|-----|-----------------|--|
| 1 | N/C | |
| 2 | N/C | |
| 3 | Ground | |
| 4 | Output | |
| 5 | N/C | |
| 6 | V _{CC} | |

| | Dimension (mm) | | |
|--------|----------------|------|--|
| Symbol | Min | Max | |
| A | | 14.9 | |
| В | | 9.7 | |
| С | | 7.0 | |
| D | 0.9 | 1.1 | |
| E | 1.6 | 1.8 | |
| F | 0.9 | 1.1 | |
| G | 2.54 nominal | | |
| Н | 2.54 nominal | | |

| Marking | | |
|------------------|---|--|
| ** Mfg Site Code | | |
| YYWWXXXXX | Serial Number (mfg date code = first 4 digits of s/n) | |



Recommended Solder Pad Geometry



Packing: Tape and Reel







Note: The temperatures shown below represent the device body temperature

| Ts max to $T_L(Ramp-up Rate)$ | 5°C/second max | |
|---|--------------------------|--|
| Preheat | | |
| Temperature Min(Ts Min) | 150°C | |
| Temperature Max.(Ts Max) | 200°C | |
| Time(ts) | 60-120 seconds | |
| Ramp-up Rate(T _L to Tp) | 3°C/second max | |
| Time Maintained Above: | | |
| Temperature(T_L) | 217°C | |
| Time(t _L) | 90 seconds max. | |
| Peak Temperature (Tp) | 245°C max for 10 seconds | |
| Time within 5°C of actual peak(t_p) | 30 seconds | |
| Ramp-down Rate | 6°C/second max | |
| Time 25°C to Peak Temperature(t) | 8 minutes max | |